

Diodes Incorporated



# SPECIFICATION FOR APPROVAL

CUSTOMER

NOMINAL FREQUENCY

12.000000 MHz

FL1200208Q

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

SPEC. NO. (P/N)

**PRODUCT TYPE** 

**CUSTOMER P/N** 

**ISSUE DATE** 

VERSION

А

October 13, 2017

APPROVED	PREPARED	QA
Brenda	Nikbi Lu	Dong Jang

#### **Diodes Incorporated**

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- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant
- \*AEC-Q200 Compliant

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL
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#### FL1200208Q

VER. A 13-Oct-17

### **VERSION HISTORY**

Version No.	Version Date	Description	Notes	
A	Oct.13,2017	Initial Release		



# TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

#### FL1200208Q

VER. A 13-Oct-17

#### **ELECTRICAL SPECIFICATIONS**

ltem	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	12.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	8	pF	
Calibration Tolerance	FL	±15	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +125	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±50	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	120	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

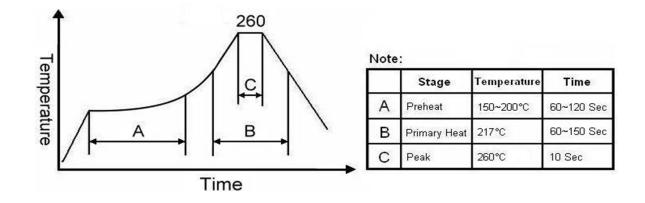
\* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



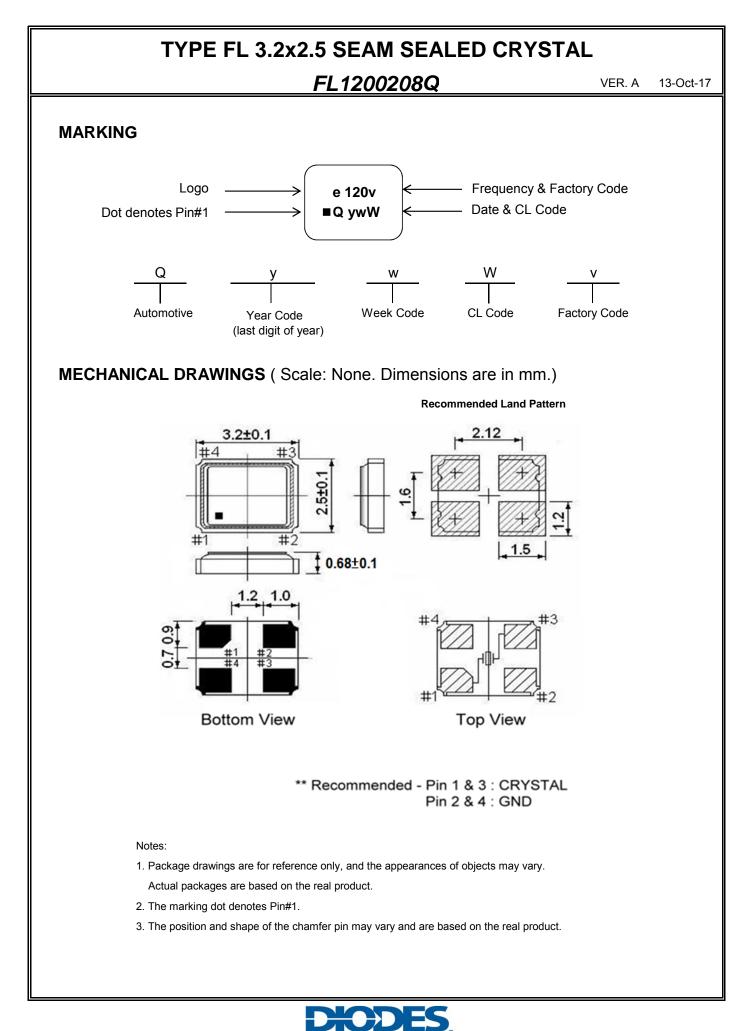
### **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL**

#### FL1200208Q

# **AEC-Q200 RELIABILITY TEST SPECIFICATIONS:** 1. Initial 1.1 Physical Dimensions: JESD22, Method JB1-100 1.2 External Visual: MIL-STD-883, Method 2009 1.3 Freq. Vs. Temperature: Per Specification/Datasheet 2. Mechanical 2.1 Mechanical Shock: MIL-STD-202 Method 213 2.2 Vibration: MIL-STD-202 Method 204 2.3 Solderability: J-STD-002 2.4 Board Flex: AEC Q200-005 2.5 Terminal Strength (SMD): AEC Q200-006 3.Environmental 3.1 Temp Cycle: JESD22, Method JA-104 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210 3.3 High Temperature Operating Life: MIL-STD-202, Method 108 3.4 High Temp Exposure: MIL-STD-202, Method 108 3.5 High Temp & High Humidity: MIL-STD-202, Method 103 3.6 Thermal Shock: MIL-STD-202, Method 107 SUGGESTED IR REFLOW PROFILE \*As per IPC-JEDEC J-STD-020D









## **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL** FL1200208Q VER. A 13-Oct-17 Tape & Reel Index Mark 2.0 0.25±0.05 Ø1.55 Ø1.0 4.0 1.75 R0.3 $\oplus$ (MAX. 3.5±0.05 8±0.2 3.4 52 2.7 Feeding 8.0 1.4 Ø60.2±0.5 78-8 9.0±0.3 12±1.4

- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.



